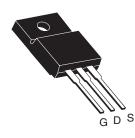


### 2SK1419-VB Datasheet N-Channel 60 V (D-S) MOSFET

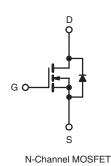
PRODUCT SUMMARY							
V <sub>DS</sub> (V)	60						
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = 10 V	0.027					
Q <sub>g</sub> (Max.) (nC)	95						
Q <sub>gs</sub> (nC)	27						
Q <sub>gd</sub> (nC)	46						
Configuration	Single						

### **FEATURES**

- · Isolated Package
- High Voltage Isolation = 2.5 kV<sub>RMS</sub> (t = 60 s; f = 60 Hz)
- Sink to Lead Creepage Distance = 4.8 mm
- 175 °C Operating Temperature
- · Dynamic dV/dt Rating
- Low Thermal Resistance
- · Lead (Pb)-free Available



**TO-220 FULLPAK** 



ABSOLUTE MAXIMUM RATINGS T<sub>C</sub> = 25 °C, unless otherwise noted SYMBOL PARAMETER LIMIT UNIT 60 **Drain-Source Voltage**  $V_{DS}$ v Gate-Source Voltage ± 20  $V_{GS}$  $T_C = 25 \ ^{\circ}C$ 45 V<sub>GS</sub> at 10 V **Continuous Drain Current**  $I_D$  $T_C = 100 \degree C$ А 30 Pulsed Drain Currenta I<sub>DM</sub> 220 Linear Derating Factor 0.32 W/°C Single Pulse Avalanche Energy<sup>b</sup> E<sub>AS</sub> 100 mJ T<sub>C</sub> = 25 °C Maximum Power Dissipation 52 W  $\mathsf{P}_\mathsf{D}$ Peak Diode Recovery dV/dtc dV/dt V/ns 4.5 - 55 to + 175 Operating Junction and Storage Temperature Range T<sub>J</sub>, T<sub>stg</sub> °C Soldering Recommendations (Peak Temperature) for 10 s 300<sup>d</sup> 10 lbf · in Mounting Torque 6-32 or M3 screw N · m 1.1

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b.  $V_{DD} = 25 \text{ V}$ , starting  $T_J = 25 \text{ °C}$ , L = 129  $\mu$ H,  $R_G = 25 \Omega$ ,  $I_{AS} = 30 \text{ A}$  (see fig. 12). c.  $I_{SD} \le 52 \text{ A}$ , dI/dt  $\le 250 \text{ A}/\mu$ s,  $V_{DD} \le V_{DS}$ ,  $T_J \le 175 \text{ °C}$ .

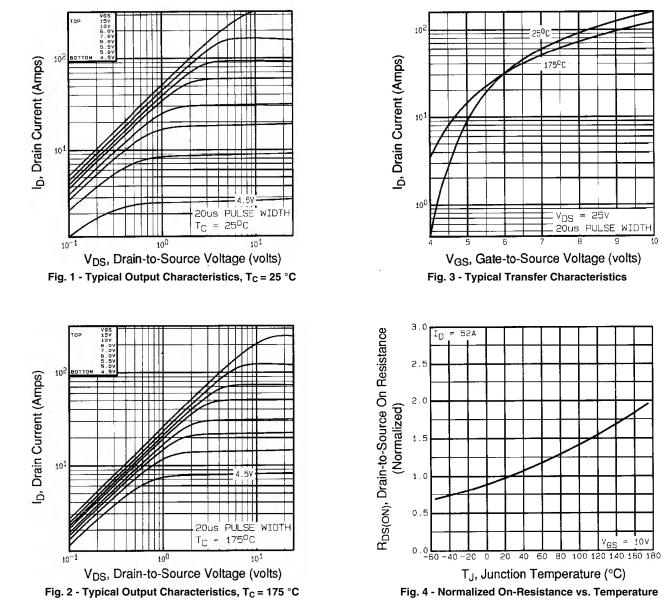
d. 1.6 mm from case.

THERMAL RESISTANCE RAT	TINGS								
PARAMETER	SYMBOL	ТҮР	•	MAX.			UNIT		
Maximum Junction-to-Ambient	R <sub>thJA</sub>	- 65			°C/W				
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	- 3.1				°C/W			
<b>SPECIFICATIONS</b> $T_J = 25 \ ^{\circ}C$ ,					1	r	1	1	
PARAMETER	SYMBOL	TEST CONDITIONS			MIN.	TYP.	MAX.	UNIT	
Static		1			T	T	T		
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS}$ = 0 V, $I_D$ = 250 $\mu$ A			60	-	-	V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, $I_D = 1 \text{ mA}$			-	0.060	-	V/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$			1.0	-	3.0	V	
Gate-Source Leakage	I <sub>GSS</sub>	V <sub>GS</sub> = ± 20 V			-	-	± 100	nA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			-	-	25	μA	
		V <sub>DS</sub> = 48 V,	$V_{DS} = 48 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 150 ^{\circ}\text{C}$			-	250		
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub>	= 18 A <sup>b</sup>	-	0.027	-	Ω	
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> =	= 25 V, I <sub>D</sub> =	18 A <sup>b</sup>	15	-	-	S	
Dynamic					•	•			
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 25 V, f = 1.0 MHz, see fig. 5		-	1500	-	pF		
Output Capacitance	C <sub>oss</sub>			-	720	-			
Reverse Transfer Capacitance	C <sub>rss</sub>			-	100	-			
Drain to Sink Capacitance	С	f = 1.0 MHz			-	12		-	
Total Gate Charge	Q <sub>g</sub>				-	-	95		
Gate-Source Charge	Q <sub>gs</sub>			A, $V_{DS} = 48 V$ ,	-	-	27	nC	
Gate-Drain Charge	Q <sub>gd</sub>		see fig. 6 and 13 <sup>b</sup>		-	-	46		
Turn-On Delay Time	t <sub>d(on)</sub>				-	19	-		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 30 V, I <sub>D</sub> = 52 A, R <sub>G</sub> = 9.1 Ω, R <sub>D</sub> = 0.54 Ω, see fig. 10 <sup>b</sup>		-	120	-	ns		
Turn-Off Delay Time	t <sub>d(off)</sub>			-	55	-			
Fall Time	t <sub>f</sub>	see ng. 10			-	86		-	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact			-	4.5	-	nH	
Internal Source Inductance	L <sub>S</sub>				-	7.5	-		
Drain-Source Body Diode Characteristic	s	•			•			•	
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the		-	-	45	A		
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>	integral reverse p - n junction diode			-	-		120	
Body Diode Voltage	$V_{SD}$	$T_J = 25 \ ^{\circ}C, \ I_S = 30 \ A, \ V_{GS} = 0 \ V^b$			-	-	2.5	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>	$T_J = 25 \text{ °C}, I_F = 52 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}^b$			-	140	300	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>				-	1.2	2.8	μC	
Forward Turn-On Time	t <sub>on</sub>	Intrinsic tu	rn-on time i	s negligible (turn	-on is dor	ninated by	y L <sub>S</sub> and I	_D)	

#### Notes

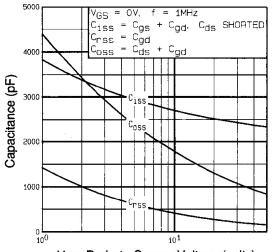
a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %.





### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





V<sub>DS</sub>, Drain-to-Source Voltage (volts) Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

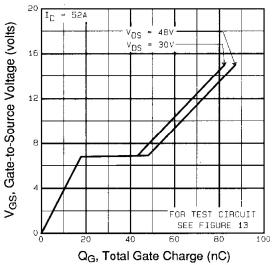


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

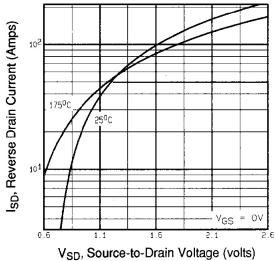
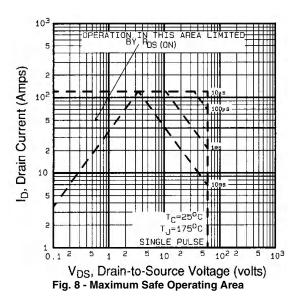


Fig. 7 - Typical Source-Drain Diode Forward Voltage



### 2SK1419-VB



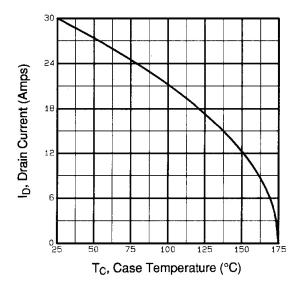


Fig. 9 - Maximum Drain Current vs. Case Temperature

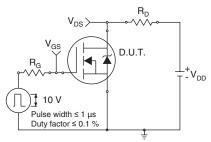


Fig. 10a - Switching Time Test Circuit

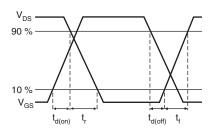


Fig. 10b - Switching Time Waveforms

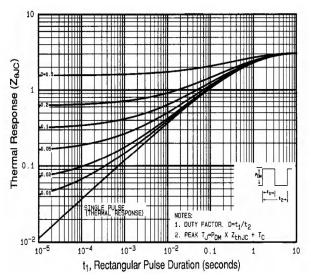
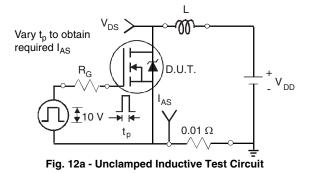


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



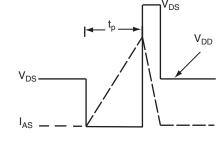
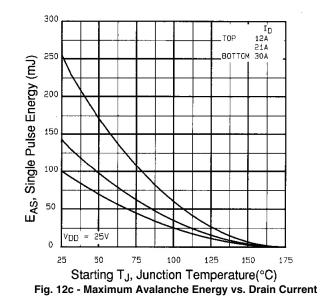


Fig. 12b - Unclamped Inductive Waveforms





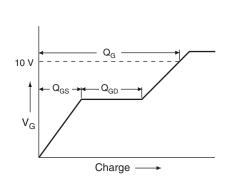


Fig. 13a - Basic Gate Charge Waveform

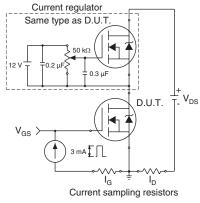
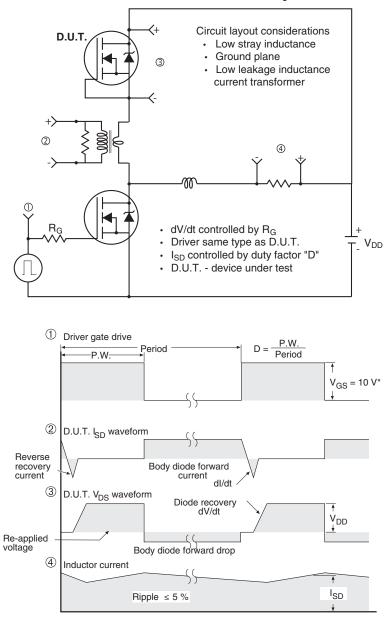


Fig. 13b - Gate Charge Test Circuit





Peak Diode Recovery dV/dt Test Circuit

\*  $V_{GS} = 5$  V for logic level devices

Fig. 14 - For N-Channel



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